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Problem 1: Operating regimes of an illuminated photodiode

Figure 1 shows the current-voltage characteristic of a photodiode with and without irradiation. In the following you can assume that the internal photocurrent *i* depends linearly on the incident optical power $i = SP_e$, where S is the responsivity of the diode.



Figure 1: Equivalent circuit of a photodiode for the DC case. (a) Circuit model: P_e incident optical power, *S* responsivity, G_p parasisitic admittance, R_s serial resistance, R_a external resistance, u_b bias voltage, i_a and u_a current and voltage in the outer circuit. (b) Transimpedance amplifier providing zero input impedance. (c) i_a - u_a -characteristics for different photocurrents *i*. $U_{BR} = 182$ V breakthrough voltage, R_{BR} differential resistance at breakthrough. Note the different scaling on the x-axis!

- a) Consider first the case where the photodiode is operated with a fixed resistor R_a in the outer circuit. How should the bias voltage u_b be chosen to obtain a linear relation between the incident optical power P_e and the diode current i_a in the outer circuit.
- b) Now the bias is fixed at $u_b = 10$ V, and the photocurrent i_a is determined by measuring the voltage drop $u_m = R_a i_a$ over the external resistor R_a . How would you choose the value of the resistor to obtain a sensitive measurement, where small changes in the incident optical power lead to large changes in the measured voltage? What are the effects on the dynamic range in this configuration, i.e., the input power range over which a linear relationship between P_e and u_m can be assumed?

- c) Now the resistor R_a is replaced by a transimpedance amplifier (TIA), Fig. 1 (b). Sketch the dependence of u_a over i_a for a given bias u_b into the diagram of Fig. 1 as already done for several values of R_a . Give an expression for the output voltage u_m ' of the TIA in dependence of the current in the outer circuit i_a .
- d) Indicate roughly the operating point in which maximum energy can be extracted from the device in photo-voltaic operation.

Problem 2: Operation principles of a pin diode

Assume a one-dimensional model of the pin diode as shown in Figure 2, where the light is incident from the left. In this model all physical quantities depend only on the *x*-coordinate. The cross-sectional area of the photodiode is denoted as *A*. Assume a complete ionization of donor/acceptor impurities ("Störstellenerschöpfung"). In the following the device is strongly biased in reverse direction such that all carriers in the intrinsic zone travel at their saturation drift velocity.



Figure 2: Schematic of a pin-diode, which comprises an intrinsic semiconductor sandwiched by a p- and an ndoped layer. This leads to the formation of the contact region (CR), the diffusion zone (DZ) and the space-charge region (SCR), which is also called depletion region. The width of the n-doped (p-doped) semiconductor is denoted as $d_n (d_p)$ and w_A is the width of the intrinsic absorption zone. The structure is not drawn to scale.

- a) In this configuration, the electric field can be expressed as $\vec{E}(x) = E(x)\vec{e}_x$. How is the electric field E(x) related to the space charge distribution $\rho(x)$. Sketch the space charge profile and the electric field as a function of x. The depletion approximation ("Schottky-Näherung") holds. Assume that the dielectric constant ε_r is constant over the device length.
- b) Assume now that the intrinsic zone has a smaller ε_r than the surrounding regions and sketch the corresponding *E*-field profile.
- c) In practice it is technologically not possible to avoid a slight (p- or n-) doping of the absorption zone. How does this change E(x)? Give a qualitative remark, no calculation necessary.

d) From Maxwell's equations it is given that $\nabla \times \vec{H} = \vec{J} + \varepsilon \frac{\partial \vec{E}}{\partial t}$. Using this relation and the one-dimensional approximation show that the sum of the transport and displacement currents in the photodiode is independent of *x*,

$$\frac{\partial}{\partial x}\left(i_n(x,t)+i_p(x,t)+A\varepsilon\frac{\partial E(x,t)}{\partial t}\right)=0.$$

In this relation the hole and electron currents are defined by $i_p(x,t) = J_p(x,t) \cdot A$, $i_n(x,t) = J_n(x,t) \cdot A$, where *A* is the cross-sectional area of the diode and where $J_{p,n}$ are the respective current densities. Assume that diffusion currents can be neglected compared to drift currents within the intrinsic region.

e) Consider now the case, where the diode is biased with a constant voltage U_B , i.e. $\int_{-w_A}^{0} E(x,t) dx = U_B = \text{const.}$ Using the result from d) show that the total current $i(t) = i_n(x,t) + i_p(x,t) + A\varepsilon \frac{\partial E(x,t)}{\partial t}$ depends only on the total number N_n and N_p of electrons and holes that are drifting within the intrinsic zone,

$$\dot{u}(t) = \frac{e}{\tau_n} N_n(t) + \frac{e}{\tau_p} N_p(t) ,$$

The quantities τ_n and τ_p are the carrier transit times, $\tau_{n,p} = w_A/v_{n,p}$, where v_n , v_p are the saturation drift velocities of electrons and holes.

Questions and Comments:

Matthias Lauermann Building: 30.10, Room: 2.23 Phone: 0721/608-48954 Email: <u>Matthias.Lauermann@kit.edu</u> Jörg Pfeifle Building: 30.10, Room: 2.23 Phone: 0721/608-48954 Email: Joerg.Pfeifle@kit.edu